isola

TerraGreen® 400GE

Halogen-free, Ultra Low Loss Material Tg 200°C Td 380°C Dk 3.29 Df 0.0026

IPC-4101 /134 UL - File Number E41625

TerraGreen[®] 400GE laminate materials are our most advanced ultra-high speed, halogen free ultra-low loss design solution.

PRODUCT FEATURES

Industry Recognition

- UL File Number: E41625
- RoHS Compliant

Performance Attributes

- CAF resistant
- Low moisture absorption
- Halogen free
- 0.8 mm pitch capable
- 6x 260°C reflow capable
- 6x 288°C solder float capable

Processing Advantages

- FR-4 process compatible
- Excellent Fill and Flow
- Multiple lamination cycles
- HDI technology compatible

PRODUCT AVAILABILITY

- Standard Material Offering: Laminate
- 2 to 10 mil (0.05 to 0.25 mm)
- Copper Foil Type
 - HVLP3 (VLP1) ≤1.1 micron Rz JIS
 Advanced RTF ≤2.5 micron Rz JIS

Copper Weight

- $\frac{1}{2}$, 1 and 2 oz (18, 35 and 70 μ m) available
- Thinner copper foil available
- Standard Material Offering: Prepreg
 - Tooling of prepreg panels
- Moisture barrier packaging
- Glass Fabric Availability
 - E-glass
 - Square weave glass
 - Mechanically spread glass

TerraGreen® 400GE is our Halogen Free material solution for next generation 5G infrastructure, data center systems, high end computing, wired & wireless communications and AI applications with data rates >100 Gb/s. Our novel resin system, RTF3 (<2.5 µm Rz JIS) copper foil and e-glass is our lowest cost member of the TerraGreen 400G® family of products.

The TerraGreen \circledast 400GE resin system has proven superior CAF performance on tight pitch testing. CAF performance is enhanced by the resin systems excellent interlaminar and bond line adhesion strength.

TerraGreen® 400GE is lead free compatible and sequential lamination capable and can be processed utilizing standard PCB equipment and processing steps. TerraGreen® 400GE meets UL94 V-0.

PRODUCT ATTRIBUTES



TYPICAL MARKET APPLICATIONS



ORDERING INFORMATION:

Contact your local sales representative or contact info@isola-group.com for further information.

Isola Group

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Isola GmbH

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Typical Values Table

| | | | Units | Test Method |
|--|--|----------------------------|-----------------------|--------------------------|
| | Property | Typical Value | Metric (English) | IPC-TM-650 (or as noted) |
| Glass Transition Temperature (Tg) by DSC | | 200 | °C | 2.4.25C |
| Glass Transition Temperature (Tg) by DMA | | 215 | °C | 2.4.24.4 |
| Glass Transition Temperature (Tg) by TMA | | 180 | °C | 2.4.24C |
| Decomposition Temperature (Td) by TGA @ 5% weight loss | | >380C | °C | 2.4.24.6 |
| Time to Delaminate by TMA (Copper removed) | A. T288 B. T300 | 60+ | Minutes | 2.4.24.1 |
| Z-Axis CTE | A. Pre-Tg B. Post-Tg C. 50 to 260°C, (Total Expansion) | 37 170 1.8 | ppm/°C ppm/°C % | 2.4.24C |
| X/Y-Axis CTE | | 12/13 | ppm/°C | 2.4.24C |
| Thermal Conductivity | | 0.54 | W/m·K | ASTM E1952 |
| Thermal Stress 10 sec @ 288ºC (550.4ºF) | A. Unetched B. Etched | Pass | Pass Visual | 2.4.13.1 |
| Dk, Permittivity | A. @ 10 GHz B. @ 20 GHz | 3.29 3.25 | _ | 2.5.5.5 |
| Df, Loss Tangent | A. @ 10 GHz B. @ 20 GHz | 0.0026 | _ | 2.5.5.5 |
| Volume Resistivity | C-96/35/90 | 2.0x10 ⁸ | MΩ-cm | 2.5.17.1 |
| Surface Resistivity | C-96/35/90 | 2.0x10 ⁷ | MΩ | 2.5.17.1 |
| Dielectric Breakdown | | 70 | kV | 2.5.6B |
| Arc Resistance | | 180 | Seconds | 2.5.1B |
| Electric Strength (Laminate & laminated prepreg) | | 67 (1700) | kV/mm (V/mil) | 2.5.6.2A |
| Comparative Tracking Index (CTI) | | 2 (250-499) | Class (Volts) | UL 746A ASTM D3638 |
| Peel Strength | A. Low profile and very low profile copper foilB. Low profile and very low profile copper foil After thermal stress | 0.7 (4.1) | N/mm (lb/inch) | 2.4.8C 2.4.8.2A |
| Flexural Strength | A. Length direction B. Cross direction | 393 (57) 338 (49) | MPa (kpsi) | 2.4.4B |
| Tensile Strength | A. Length direction B. Cross direction | 220 (32) 193 (28) | MPa (kpsi) | ASTM D3039 |
| Young's Modulus | A. Length direction B. Cross direction | 14.5 (2100) 13.0 (1900) | GPa(kpsi) | ASTM D790-15e2 |
| Flexural Modulus | A. Lengthwise B. Crosswise | 12.1 (1750) 11.7(1700) | GPa (kpsi) | ASTM D790-15e2 |
| Moisture Absorption | | <0.1 | % | 2.6.2.1A |
| Flammability (Laminate & laminated prepreg) | | V-0 | Rating | UL 94 |
| Relative Thermal Index (RTI) | | 140 | °C | UL 746 |

NOTES

Visit our site <u>http://www.isola-group.com</u> for more details. Revisions:

A: Initial release - 1/23

- B: Corrected units for Youngs Modulus from MPa to GPa 1/24
- C: Corrected laminate thickness offering from maximum 18 mils to 10 mils, updated copper foil offering 3/24

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